



YEA SHIN TECHNOLOGY CO., LTD

YS2603ZBB

P-Channel Enhancement MOSFET

V_{DS}= -20V, ID= -60A



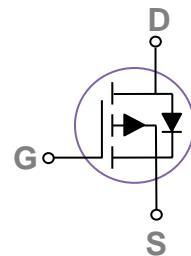
Features

- -20V,-60A, R_{DSON} = 8mΩ@V_{GS} = -4.5V
- Improved dv/dt capability
- Fast switching
- Green Device Available
- Suit for -1.8V Gate Drive Applications

Applications

- Notebook
- Load Switch
- Networking
- Hand-Held Instruments

PPAK3x3 Pin Configuration



Absolute Maximum Ratings T_c=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-20	V
V _{GS}	Gate-Source Voltage	±12	V
I _D	Drain Current – Continuous (T _c =25°C)	-60	A
	Drain Current – Continuous (T _c =100 °C)	-38	A
I _{DM}	Drain Current – Pulsed ¹	-240	A
P _D	Power Dissipation (T _c =25°C)	62.5	W
	Power Dissipation – Derate above 25°C	0.5	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C /W
R _{θJC}	Thermal Resistance Junction to Case	---	2	°C /W

DEVICE CHARACTERISTICS

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Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_D=-250\mu\text{A}$	-20	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $\text{I}_D=-1\text{mA}$	---	-0.01	---	$^\circ\text{C}$
I_{DS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=-20\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	-1	μA
		$\text{V}_{\text{DS}}=-16\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$	---	---	-10	μA
I_{GS}	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=\pm 12\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$\text{R}_{\text{DS(ON)}}$	Static Drain-source On-Resistance	$\text{V}_{\text{GS}}=-4.5\text{V}$, $\text{I}_D=-8\text{A}$	---	6	8	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-2.5\text{V}$, $\text{I}_D=-5\text{A}$	---	8	11	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-1.8\text{V}$, $\text{I}_D=-3\text{A}$	---	11	16	$\text{m}\Omega$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$, $\text{I}_D=-250\mu\text{A}$	-0.3	-0.6	-1	V
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}}=-10\text{V}$, $\text{I}_D=-5\text{A}$	---	20	---	S

Dynamic and Switching Characteristics

Q_g	Total Gate Charge ^{2,3}	$\text{V}_{\text{DS}}=-10\text{V}$, $\text{V}_{\text{GS}}=-4.5\text{V}$, $\text{I}_D=-5\text{A}$	---	44.4	80	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	7.2	14	
Q_{gd}	Gate-Drain Charge ^{2,3}		---	10.2	20	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time ^{2,3}	$\text{V}_{\text{DD}}=-10\text{V}$, $\text{V}_{\text{GS}}=-4.5\text{V}$, $\text{R}_G=25\Omega$, $\text{I}_D=-1\text{A}$	---	13.2	26	ns
T_r	Rise Time ^{2,3}		---	68	120	
$\text{T}_{\text{d(off)}}$	Turn-On Delay Time ^{2,3}		---	160	320	
T_f	Fall Time ^{2,3}		---	154	300	
C_{iss}	Input Capacitance		---	4060	8000	pF
C_{oss}	Output Capacitance	$\text{V}_{\text{DS}}=-15\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	520	1000	
C_{rss}	Reverse Transfer Capacitance		---	400	800	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$\text{V}_G=\text{V}_D=0\text{V}$, Force Current	---	---	-60	A
I_{SM}	Pulsed Source Current		---	---	-120	A
V_{SD}	Diode Forward Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_s=-1\text{A}$, $T_J=25^\circ\text{C}$		---	-1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

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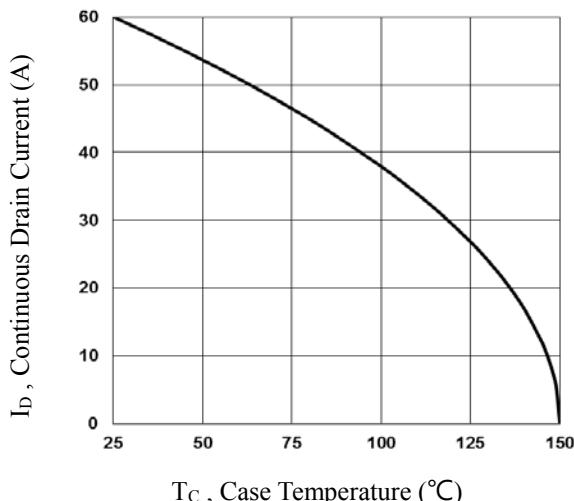


Fig.1 Continuous Drain Current vs. T_c

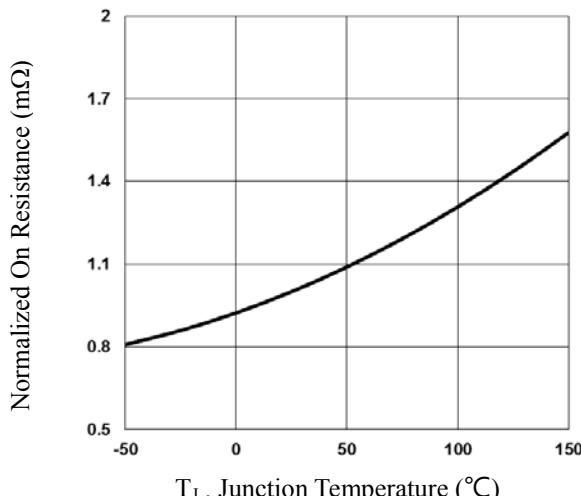


Fig.2 Normalized RDS(on) vs. T_j

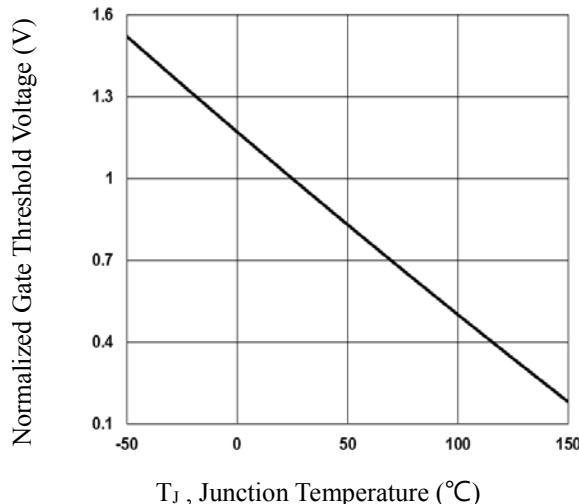


Fig.3 Normalized V_{th} vs. T_j

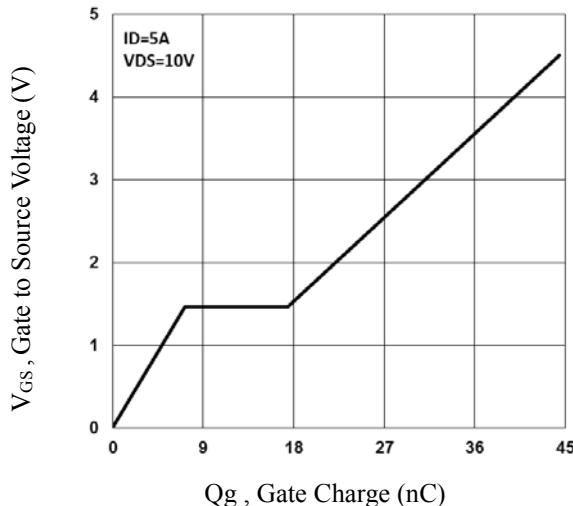


Fig.4 Gate Charge Waveform

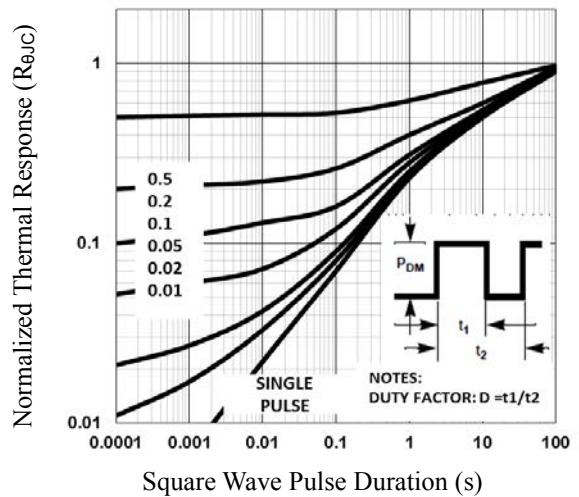


Fig.5 Normalized Transient Impedance

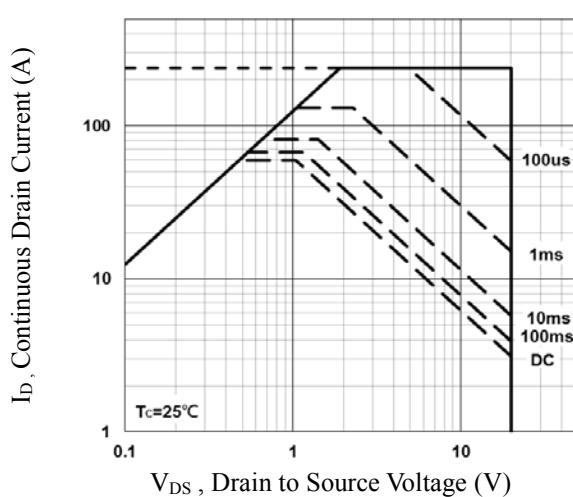
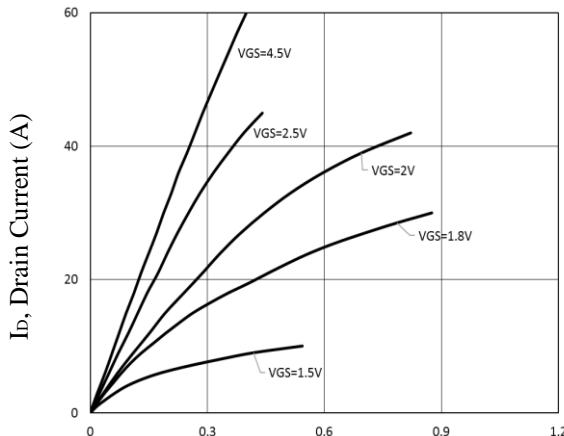


Fig.6 Maximum Safe Operation Area

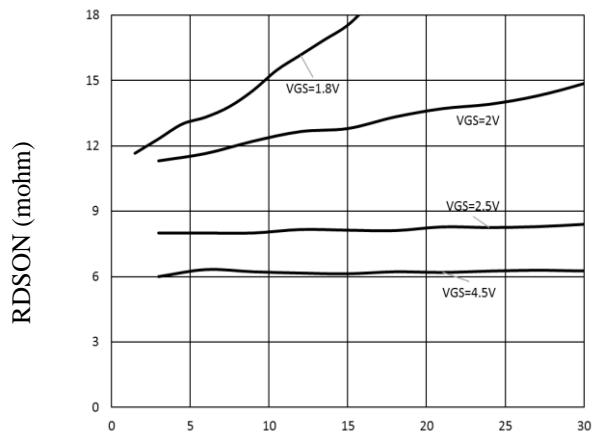
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V_{DS} , Drain to Source Voltage

Fig. 7 Typical Output Characteristics



I_D , Drain Current (A)

Fig. 8 RDSON vs. Drain Current

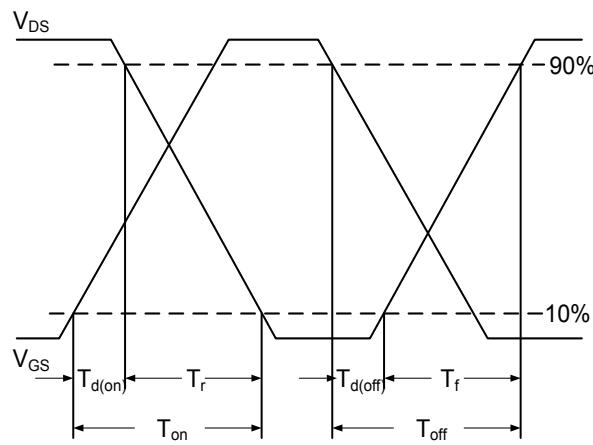


Fig. 9 Switching Time Waveform

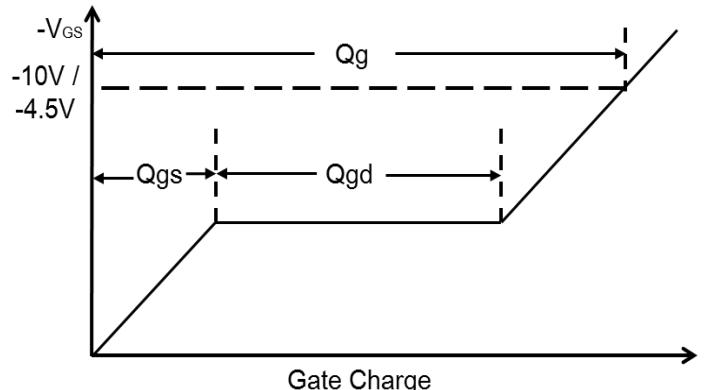
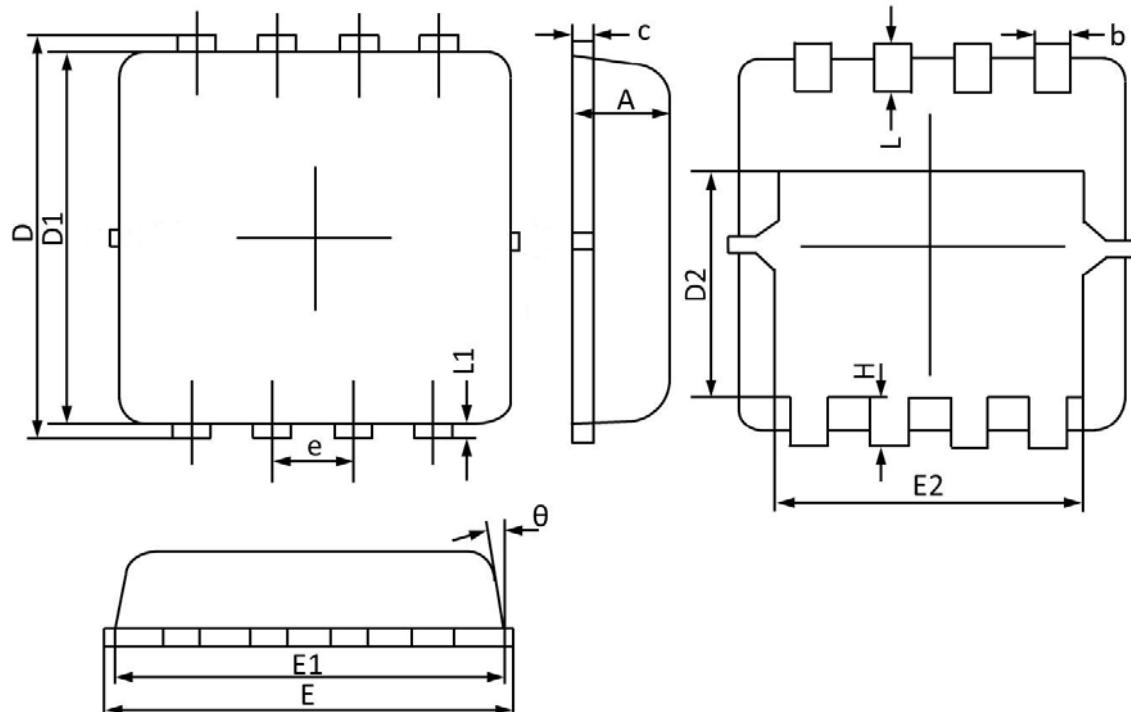


Fig. 10 Gate Charge Waveform

PACKAGE OUTLINE & DIMENSIONS

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PPAK3x3 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.900	0.028	0.035
b	0.240	0.350	0.009	0.014
c	0.100	0.250	0.004	0.010
D	3.050	3.450	0.120	0.136
D1	2.900	3.200	0.114	0.126
D2	1.350	1.850	0.053	0.073
E	3.000	3.400	0.118	0.134
E1	2.900	3.250	0.114	0.128
E2	2.350	2.600	0.093	0.102
e	0.650 BSC		0.026 BSC	
H	0.300	0.500	0.012	0.020
L	0.300	0.500	0.012	0.020
L1	0.070	0.200	0.003	0.008
θ	0°	12°	0°	12°